

Octal Transparent Latch, 3-State

CD54/74AC/ACT373 - Non-Inverting CD54/74AC/ACT533 - Inverting

Type Features:

Buffered inputs

Typical propagation delay:

4.3 ns @ Vcc = 5 V, TA = 25° C, CL = 50 pF

FUNCTIONAL DIAGRAM

The RCA-CD54/74AC373 and CD54/74AC533 and the CD54/74ACT373 and CD54/74ACT533 octal transparent 3-state latches use the RCA ADVANCED CMOS technology. The outputs are transparent to the inputs when the Latch Enable (\overline{LE}) is HIGH. When the Latch Enable (\overline{LE}) goes LOW, the data is latched. The Output Enable (\overline{OE}) controls the 3-state outputs. When the Output Enable (\overline{OE}) is HIGH, the outputs are in the high-impedance state. The latch operation is independent of the state of the Output Enable.

The CD74AC/ACT373 and CD74AC/ACT533 are supplied in 20-lead dual-in-line plastic packages (E suffix) and in 20-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70° C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC/ACT373 and CD54AC/ACT533, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

Family Features:

- Exceeds 2-kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design
- Speed of bipolar FAST*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- ± 24-mA output drive current
- Fanout to 15 FAST* ICs
- Drives 50-ohm transmission lines

*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

Output Latch AC/ACT373 AC/ACT533 Data Enable Enable Output Output L н Н Н L Ł Н L L н L L L Ł Ĥ L L h н L н Х Х Ζ Z

TRUTH TABLE

Note:

L = Low voltage level

H = High voltage level

t = Low voltage level one set-up time prior to the high to low latch enable transition h = High voltage level one set-up time prior to the high to low latch enable transition.

= Don't Care

Z = High Impedance State

This data sheet is applicable to the CD54/74AC373, CD54/74ACT373, and CD54ACT533. The CD74AC533 and CD74ACT533 were not acquired from Harris Semiconductor.

File Number 1882

CD54/74AC373, CD54/74AC533 CD54/74ACT373, CD54/74ACT533

MAXIMUM RATINGS, Absolute-Maximum Values:
DC SUPPLY-VOLTAGE (V _{cc})
DC INPUT DIODE CURRENT, I _{ik} (for $V_1 < -0.5$ V or $V_1 > V_{cc} + 0.5$ V) +20 mA
500019010000000000000000000000000000000
DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, l_0 (for $V_0 > -0.5$ V or $V_0 < V_{cr} + 0.5$ V)
UC Vαc OF GHOUND CURRENT (Icc OF IGND)
POWER DISSIPATION PER PACKAGE (P_0):
For $T_A = -55$ to $\pm 100^{\circ}$ C (PACKAGE TYPE E)
For $I_A = +100$ to $+125^{\circ}$ C (PACKAGE TYPE E) Derate Linearly at 8 mW/°C to 300 mW
For $I_A = -55$ to $+70^{\circ}$ C (PACKAGE TYPE M)
For $I_A = +70$ to $+125^{\circ}$ C (PACKAGE TYPE M) Derate Linearly at 6 mW/°C to 70 mW
OPERATING-TEMPERATURE RANGE (T_A)
STORAGE LEMPERATURE (1sto)
LEAD TEMPERATURE (DURING SOLDERING):
At distance 1/16 \pm 1/32 in. (1.59 \pm 0.79 mm) from case for 10 s maximum
Unit inserted into PC board min. thickness 1/16 in. (1.59 mm) with solder contacting lead tips only +300°C
*For up to 4 outputs per device; add \pm 25 mA for each additional output.

RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIN	LIMITS		
	MIN.	MAX.		
Supply-Voltage Range, Vcc*:		1	1	
(For $T_A = Full Package-Temperature Range)$	·			
AC Types	1.5	5.5		
ACT Types	4.5	5.5	V	
DC Input or Output Voltage, VI, Vo	0	Vcc	V	
Operating Temperature, TA	-55	+125	°C	
Input Rise and Fall Slew Rate, dt/dv				
at 1.5 V to 3 V(AC Types)	0	50	ns/V	
at 3.6 V to 5.5 V(AC Types)	Ō	20	ns/V	
at 4.5 V to 5.5 V(ACT Types)	0	10	ns/V	

'Unless otherwise specified, all voltages are referenced to ground.

TERMINAL ASSIGNMENT DIAGRAMS



CD54/74AC373, CD54/74ACT373

CD54/74AC533, CD54/74ACT533

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STATIC ELECTRICAL CHARACTERISTICS: AC Series

						AMBIEN	Г ТЕМРЕ	RATURE	(T _A) - °(<u> </u>	
CHARACTERISTICS		TEST CONDITIONS		V _{cc}	+25		-40 to +85		-55 to +125		UNITS
		V, (V)	l _o (mA)	(Ÿ)	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
High-Level Input				1.5	1.2		1.2	-	1.2		
Voltage	ViH			3	2.1	_	2.1	—	2.1	—] v
				5.5	3.85		3.85	-	3.85	—	
Low-Level Input				1.5		0.3	_	0.3		0.3	
Voltage	Vil			3		0.9		0.9	<u> </u>	0.9) v
				5.5	· _	1.65	_	1.65		1.65]
High-Level Output			-0.05	1.5	1.4	-	1.4	_	1.4	-	
Voltage	In-Level Output /oltage Vон	ViH	-0.05	3	2.9		2.9	-	2.9]
		or	-0.05	4.5	4.4	_	4.4	_	4.4	-]
		ViL	-4	3	2.58	_	2.48		2.4	-] v [
			-24	4.5	3.94	-	3.8	_	3.7	-] .
		#, * {	-75	5.5	'	_	3.85	_		—]
		#, * {	-50	5.5	_		-	_	3.85	_]
Low-Level Output		hh	0.05	1.5	_	0.1		0.1	_	0.1	
Voltage	Vol	ViH	0.05	3	_	0.1	-	0.1	-	0,1	
		or	0.05	4.5	-	0.1	_	0.1	_	0.1	1
		VIL	12	3		0.36		0.44	_	0.5] v
			24	4.5		0.36	_	0.44		0.5	
		1 (75	5.5	_			1.65			1
		#, * {	50	5.5		-	-	-		1.65	1
Input Leakage Current	l _i	V _{cc} or GND		5.5		±0.1	_	±1	_	±1	μA
3-State Leakage		ViH		1						T	-
Current	loz	or									
		ViL									
		V _o =		5.5	_	±0.5	_	±5	_	±10	μΑ
		Vcc									
		or		1							
		GND									
Quiescent Supply Current, MSI	lcc	V _{cc} or GND	0	5.5		8		80		160	μA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize

power dissipation. *Test verifies a minimum 50-ohm transmission-line-drive capability at +85° C, 75 ohms at +125° C.

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STATIC ELECTRICAL CHARACTERISTICS: ACT Series

						AMBIENT TEMPERATURE (TA) - °C					
CHARACTERISTICS		TEST CONDITIONS		V _{cc}	+	+25		-40 to +85		-55 to +125	
		V, (V)	l _o (mA)	(V)	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	1
High-Level Input Voltage	Vін			4.5 to 5.5	2	-	2	_	2	_	v
Low-Level Input Voltage	ViL		1	4.5 to 5.5		0.8	_	0.8	-	0.8	v
High-Level Output		ViH	-0.05	4.5	4.4		4.4	-	4.4		1
Voltage	V _{он}	or ViL	-24	4.5	3.94		3.8		3.7	1 _	
		#, * {	-75	5.5		1 -	3.85	- 1		- 1	-
			-50	5.5	—		-	<u> </u>	3.85	- 1	1
Low-Level Output		Vін	0.05	4.5	<u> </u>	0.1		0.1	-	0.1	, , , , , , , , , , , , , , , , , , , ,
Voltage	Vol	or Vı∟,	24	4.5		0.36		0.44	-	0.5 V	
		#, * {	75	5.5		_		1.65		-	1 V
			50	5.5	-				-	1.65	1
Input Leakage Current	4	V _{cc} or GND		5.5		±0.1	_	±1	_	±1	μA
3-State Leakage Current	loz	V _{IH} or									
		V _{IL} V _o = V _{cc}		5.5	_	±0.5		±5	_	.±10	μA
		or GND									
Quiescent Supply Current, MSI	lcc	V _{oc} or GND	0	5.5	—	8	-	80		160	μA
Additional Quiescent S Current per Input Pi TTL Inputs High 1 Unit Load	Supply n ∆I _{cc}	V _{cc} -2.1		4.5 to 5.5	_	2.4	-	2.8		3	mA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation. *Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

ACT INPUT LOADING TABLE

INPUT	UNIT LOAD*			
	ACT373	ACT533		
ŌE	0.87	0.87		
Dn	0.5	0.5		
ĹĒ	0.8	0.8		

*Unit load is Alcc limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

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PREREQUISITE FOR SWITCHING: AC Series

1999 - Fr		AMBIENT TEMP		ENT TEMPE	RATURE (1	(▲) -°C]
CHARACTERISTICS	SYMBOL	V _{cc} (V)	-40 t	o +85	-55 to	+125	
		(*)	MIN.	MAX.	MIN.	MAX.	· ·
LE Pulse Width	tw	1.5 3.3* 5†	44 4.9 3.5		50 5.6 4		ns
Setup Time Data to LE	tsu	1.5 3.3 5	2 2 2		2 2 2		ns
Hold Time Data to LE	tH	1.5 3.3 5	33 3.7 2.6		38 4.2 3		ns

*3.3 V: min. is @ 3 V

†5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: AC Series; t,, t, = 3 ns, CL = 50 pF

			AMBI	ENT TEMPE	RATURE (T	∧) - °C	
CHARACTERISTICS	SYMBOL	V _{cc} (V)	-40 to +85		-55 to	+125	
		(*)	MIN.	MAX.	MIN.	MAX.	<u> </u>
Propagation Delays: Data to Qn 373	tрін трні	1.5 3.3* 5†	 3.1 2.2	96 10.8 7.7	 3 2.1	106 11.9 8.5	ns
533	tрін tрні	1.5 3.3 5	3.8 2.7	119 13.4 9.5	 3.7 2.6	131 14.7 10.5	ns
LE on Qn 373	tрін tрні	1.5 3.3 5	 4.3 3.1	136 15.2 10.9	4.2 3	150 16.8 12	ns
533	tplh tphl	1.5 3.3 5	 4.3 3.1	136 15.3 10.9		150 16.8 12	ns
Output Enable Times	tezi. tezh	1.5 3.3 5	 4.1 2.7	119 14.4 9.5		131 15.8 10.5	ns
Output Disable Times	tplz tphz	1.5 3.3 5	 3.7 3	131 13.1 10.5	 3.6 2.9	144 14.4 11.5	ns
Power Dissipation Capacitance	CPD§		63	Тур.	63	Тур	pF
Min. (Valley) Vон During Switching of Other Outputs (Output Under Test Not Switching)	V _{онv} See Fig. 1	5	4 Typ. @ 25°C				v
Max. (Peak) Vol. During Switching of Other Outputs (Output Under Test Not Switching)	V _{OLP} See Fig. 1	5	1 Typ. @ 25°C			v	
Input Capacitance	Ci	_		10		10	pF
3-State Output Capacitance	Co	_		15	- 1	15	pF

*3.3 V: min. is @ 3.6 V max. is @ 3 V

t5 V: min. is @ 5.5 V max. is @ 4.5 V C_{PD} is used to determine the dynamic power consumption, per latch. $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ where $f_i = input$ frequency $C_L = output load capacitance$

 V_{cc} = supply voltage.

PREREQUISITE FOR SWITCHING: ACT Series

			AMBI	ENT TEMPI	ERATURE (1	Г _л) -°С	
CHARACTERISTICS	SYMBOL	V _{cc} (V)	-40 to +85		-55 to +125		
		(*)	MIN.	MAX.	MIN.	MAX.	
LÊ Pulse Width	tw	5†	3.6		4	_	ns
Setup Time Data to LE	tsu	5	2	_	2		ns
Hold Time Data to LE	t _H	5	2.7		3		ns

†5 V: min. is @ 4.5 V

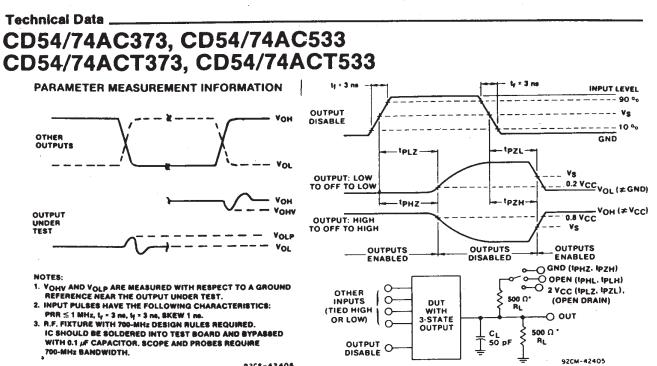
SWITCHING CHARACTERISTICS: ACT Series; t,, t, = 3 ns, CL = 50 pF

		AMBIENT TEMPERATURE (TA) -°C					
CHARACTERISTICS	SYMBOL	V _{cc} (V)	-40 to +85		-55 to +125		
		(*)	MIN.	MAX.	MIN.	MAX.	1
Propagation Delays: Data to Qn 373	tрін	<i></i>	2.7	9.5	2.6	10.4	
533	тень Г	5†	3	10.4	2.9	11.4	ns
LE to Qn 373 533	tрін tphi	5	3.1	11.4	3	12.5	ns
Output Enable Times	tezi tezh	5	3.5	12.3	3.4	13.5	ns
Output Disable Times	tplz tphz	5	3.2	11.4	3.1	12.5	ns
Power Dissipation Capacitance	CPD§		63	Тур. 63 Тур.		Гур.	pF
Min. (Valley) V _{он} During Switching of Other Outputs (Output Under Test Not Switching)	V _{онv} See Fig. 1	5	4 Typ. @ 25°C			v	
Max. (Peak) VoL During Switching of Other Outputs (Output Under Test Not Switching)	V _{OLP} See Fig. 1	5	1 Тур. @ 25°С			v	
Input Capacitance	C ₁			10	_	10	pF
3-State Output Capacitance	Co	_	_	15	_	15	pF

†5 V: min. is @ 5.5 V

max. is @ 4.5 V

 V_{CC} = supply voltage.



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10%

92 CS - 37132

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HT THL



Fig. 3 - Data to Qn output propagation delays and output

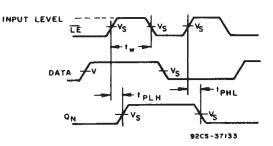
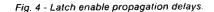


Fig. 2 - Three-state propagation delay waveforms and test circuit.

*FOR AC SERIES ONLY: WHEN VCC = 1.5 V, RL = 1 kD



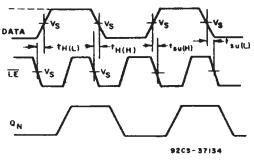


INPUT LEVEL

DATA

QN

transistion times.



	CD54/74AC	CD54/74ACT
Input Level	Vcc	3 V
Input Switching Voltage, Vs	0.5 V _{cc}	1.5 V
Output Switching Voltage, Vs	0.5 V _{cc}	0.5 V _{cc}

Fig. 5 - Latch enable prerequisite times.

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